

L Number	Hits	Search Text	DB	Time stamp
1	39265	((nickel ni) with (vanadium v))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 10:54
2	43225	((under adj (bump ball)) underball underbump) metallurgy	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 09:40
3	40496	((copper cu wet wettable wett) with (thickness measurement micron))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 10:52
4	2	((nickel ni) with (vanadium v)) same (((under adj (bump ball)) underball underbump) metallurgy) same ((copper cu wet wettable wett) with (thickness measurement micron))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 10:54
5	45	((nickel ni) with (vanadium v)) and (((under adj (bump ball)) underball underbump) metallurgy) and ((copper cu wet wettable wett) with (thickness measurement micron))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 09:44
6	52015	((copper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 10:56
7	2	((nickel ni) with (vanadium v)) same (((under adj (bump ball)) underball underbump) metallurgy) same ((copper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 10:53
8	61036	((nickel ni) with (vanadium v) niv)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 10:54
9	3	((nickel ni) with (vanadium v) niv) same (((under adj (bump ball)) underball underbump) metallurgy) same ((copper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 10:57
10	52555	((copper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron (mu with m)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 10:58
12	98	((nickel ni) with (vanadium v) niv) and (((under adj (bump ball)) underball underbump) metallurgy) and ((copper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron (mu with m)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 11:00
11	3	((nickel ni) with (vanadium v) niv) same (((under adj (bump ball)) underball underbump) metallurgy) same ((copper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron (mu with m)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 11:00
13	52652	((copper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron (mu with m) mum (mu adj3 m)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 10:59

14	3	((nickel ni) with (vanadium v) niv) same (((under adj (bump ball)) underball underbump) metallurgy) same ((copper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron (mu with m) mum (mu adj3 m)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 11:01
15	98	((nickel ni) with (vanadium v) niv) and (((under adj (bump ball)) underball underbump) metallurgy) and ((copper cu wet wettable wett) with (thickness measurement mm micrometers (micro with meter) micron (mu with m) mum (mu adj3 m)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/25 11:01

L Number	Hits	Search Text	DB	Time stamp
1	39265	(nickel ni) with (vanadium v)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/05/25 09:38
2	43225	((under adj (bump ball)) underball underbump) metallurgy	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/05/25 09:40
3	40496	(copper cu wet wettable wett) with (thickness measurement micron)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/05/25 09:41
4	2	((nickel ni) with (vanadium v)) same (((under adj (bump ball)) underball underbump) metallurgy) same ((copper cu wet wettable wett) with (thickness measurement micron))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/05/25 09:44
5	45	((nickel ni) with (vanadium v)) and (((under adj (bump ball)) underball underbump) metallurgy) and ((copper cu wet wettable wett) with (thickness measurement micron))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/05/25 09:44